

100V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

| BV _{DSS} | R _{DS(ON)} Max | I _D Max Tc = +25°C |
|-------------------|-------------------------------|----------------------------------|
| 100V | 8mΩ @ V _{GS} = 10V | 90A |
| 1000 | $12.5m\Omega @ V_{GS} = 4.5V$ | 74A |

Description

This new generation N-Channel Enhancement Mode MOSFET is designed to minimize R_{DS(ON)} yet maintain superior switching performance. This device is ideal for use in notebook battery power management and load switches.

Applications

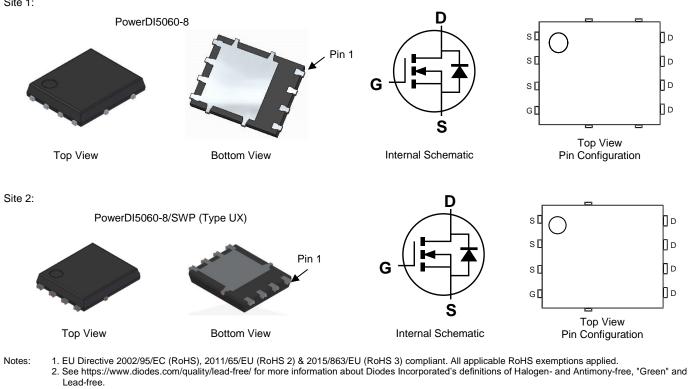
- Motor controls
- **DC-DC** converters
- Power management

Features

- Thermally Efficient Package-Cooler Running Applications
- High Conversion Efficiency
- 100% Unclamped Inductive Switching (UIS) Test in Production -• Ensures More Reliable and Robust End Application
- Low RDS(ON) Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- < 1.1mm Package Profile Ideal for Thin Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

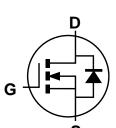
- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.097 grams (Approximate)



3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

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Site 1:



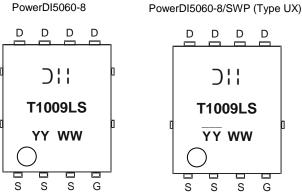


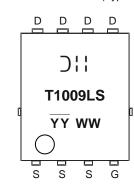
Ordering Information (Note 4)

| Part Number | Backago | Packing | | |
|------------------|-----------------------------|---------|-------------|--|
| Fait Nulliger | Package | Qty. | Carrier | |
| DMT10H009LPS-13 | PowerDI5060-8 | 2,500 | Tape & Reel | |
| DMITTOHOO9EF3-13 | PowerDI5060-8/SWP (Type UX) | 2,500 | Tape & Reel | |

Note: 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





) | | = Manufacturer's Marking T1009LS = Product Type Marking Code YYWW or $\overline{YY}WW = Date Code Marking$ YY or \overline{YY} = Last Two Digits of Year (ex: 23 = 2023) WW = Week Code (01 to 53)

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

| Characteristic | | | Symbol | Value | Unit |
|--|-----------------|--|------------------|----------|------|
| Drain-Source Voltage | | | V _{DSS} | 100 | V |
| Gate-Source Voltage | | | Vgss | ±20 | V |
| Continuous Drain Current V _{GS} = 10V (Note 5) | Steady State | T _A = +25°C T _A = +70°C | ١D | 10 8 | A |
| Continuous Drain Current V _{GS} = 10V (Note 6) | Steady State | Tc = +25°C Tc = +70°C | ١D | 90 72 | А |
| Pulsed Drain Current (10µs Pulse, T _C = +25°C, Package Limited) | | | IDM | 360 | A |
| Maximum Continuous Body Diode Forward Current | | | ls | 85 | A |
| Pulsed Body Diode Current (10µs Pulse, Tc = +25°C, Package Limited) | | | lsм | 360 | A |
| Avalanche Current (Note 7), L = 0.3mH | | | I _{AS} | 21 | A |
| Avalanche Energy (Note 7), L = 0.3mH | | | Eas | 66 | mJ |
| V _{DS} Spike, L = 0.1mH t = 10µs | | | VSPIKE | 110 | V |

Thermal Characteristics

| Characteristic | | Symbol | Value | Unit |
|--|------------------------|------------------|-------------|------|
| Total Power Dissipation (Note 8) | T _A = +25°C | PD | 1.3 | W |
| Thermal Resistance, Junction to Ambient (Note 8) | Steady State | R _{0JA} | 98 | °C/W |
| Total Power Dissipation (Note 5) | T _A = +25°C | PD | 2.9 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State | Reja | 43 | °C/W |
| Total Power Dissipation (Note 6) | Tc = +25°C | PD | 104 | W |
| Thermal Resistance, Junction to Case (Note 6) | | R _{0JC} | 1.2 | °C/W |
| Operating and Storage Temperature Range | | TJ, TSTG | -55 to +150 | °C |

5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad).

7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_{J} = +25°C.

8. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

Notes:



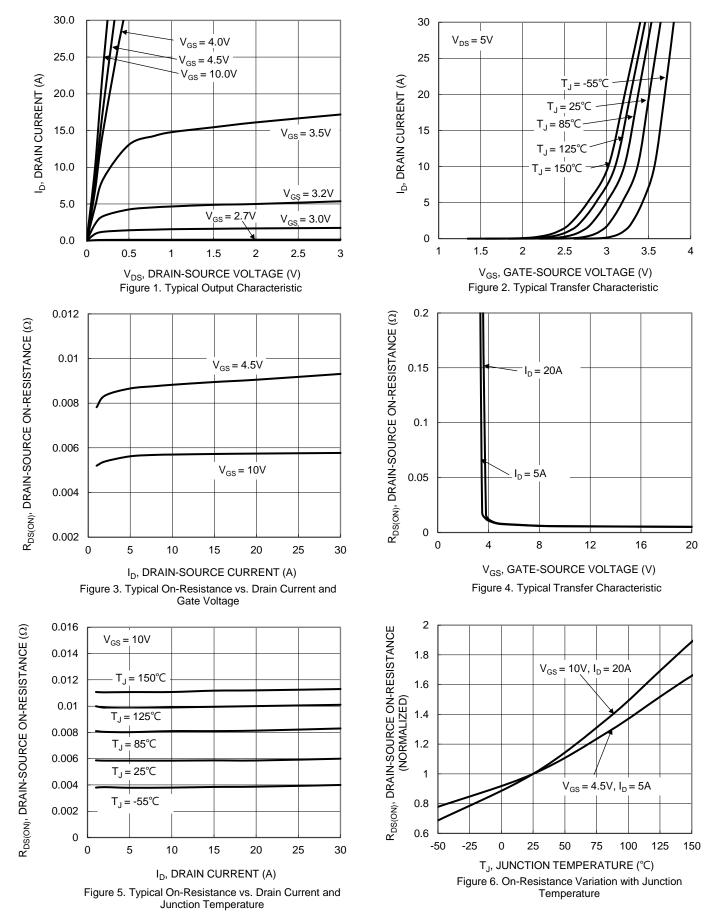
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|--|---------------------|-------|------|------|------|--|--|
| OFF CHARACTERISTICS (Note 9) | Cymbol | WIIII | Typ | Max | Onit | Test condition | |
| Drain-Source Breakdown Voltage | BVpss | 100 | _ | | V | $V_{GS} = 0V, I_D = 1mA$ | |
| Zero Gate Voltage Drain Current | IDSS | _ | _ | 1 | μA | $V_{DS} = 80V, V_{GS} = 0V$ | |
| Gate-Source Leakage | lgss | _ | _ | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 9) | | | • | | • | ÷ | |
| Gate Threshold Voltage | Vgs(th) | 1.2 | _ | 2.5 | V | $V_{DS} = V_{GS}$, $I_D = 250 \mu A$ | |
| Statia Duaia Causa On Desistance | D | | 6 | 8 | mΩ | V _{GS} = 10V, I _D = 20A | |
| Static Drain-Source On-Resistance | R _{DS(ON)} | _ | 9 | 12.5 | 1117 | $V_{GS} = 4.5V, I_D = 5A$ | |
| Diode Forward Voltage | Vsd | — | 0.8 | 1.2 | V | V _{GS} = 0V, I _S = 13A | |
| DYNAMIC CHARACTERISTICS (Note 10) | | | | | | | |
| Input Capacitance | Ciss | _ | 2309 | — | pF | $V_{DS} = 50V, V_{GS} = 0V$ f = 1MHz | |
| Output Capacitance | Coss | _ | 536 | _ | | | |
| Reverse Transfer Capacitance | Crss | — | 13.7 | — | | | |
| Gate Resistance | Rg | — | 1.9 | _ | Ω | $V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$ | |
| Total Gate Charge (V _{GS} = 10V) | Qg | — | 40.2 | | | V _{DD} = 50V, I _D = 20A | |
| Total Gate Charge (V _{GS} = 4.5V) | Qg | — | 20.2 | — | nC | | |
| Gate-Source Charge | Qgs | — | 7.0 | — | ne | | |
| Gate-Drain Charge | Q _{gd} | — | 8.5 | | | | |
| Turn-On Delay Time | tD(ON) | _ | 5.4 | _ | | $V_{DD} = 50V, V_{GS} = 10V$ $I_D = 20A, R_g = 3\Omega$ | |
| Turn-On Rise Time | tR | _ | 10.6 | _ | ns | | |
| Turn-Off Delay Time | tD(OFF) | _ | 28.3 | _ | | | |
| Turn-Off Fall Time | tF | | 14.9 | _ |] | | |
| Reverse Recovery Time | trr | _ | 44.3 | _ | ns | 1 = -200 dl/dt = 1000/uc | |
| Reverse Recovery Charge | Qrr | | 65.5 | _ | nC | $I_F = 20A, dI/dt = 100A/\mu s$ | |

Notes: 9. Short duration pulse test used to minimize self-heating effect. 10. Guaranteed by design. Not subject to product testing.



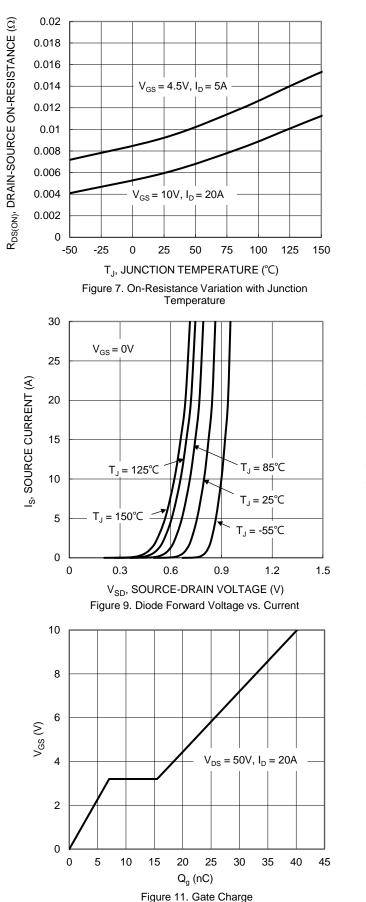
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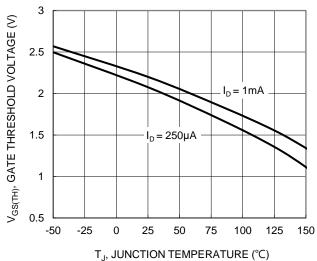
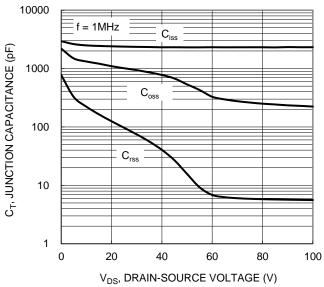
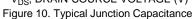
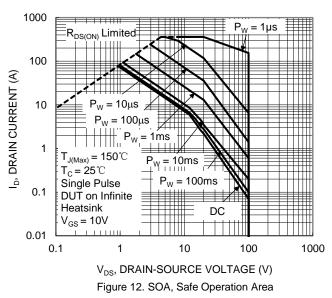


Figure 8. Gate Threshold Variation vs. Junction Temperature



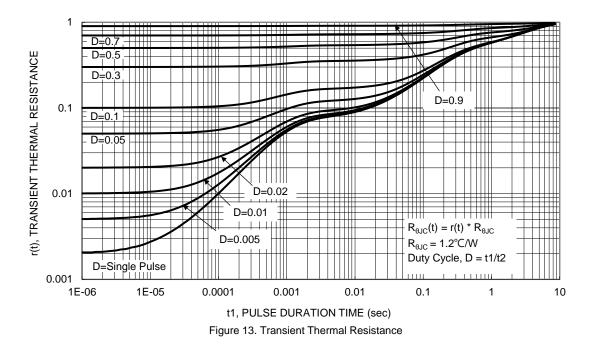




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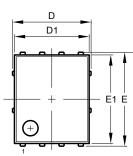


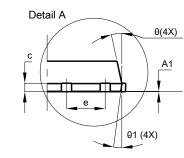
Package Outline Dimensions

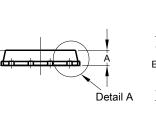
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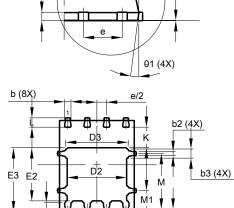
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Site 1:



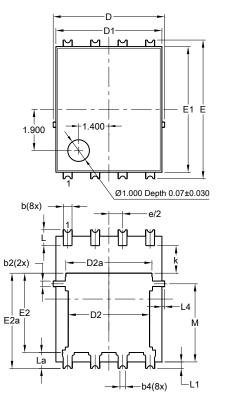






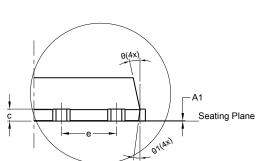
| | PowerDI5060-8 | | | | |
|-----|----------------------|----------|-------|--|--|
| Dim | Min | Max | Тур | | |
| Α | 0.90 | 1.10 | 1.00 | | |
| A1 | 0.00 | 0.05 | - | | |
| b | 0.33 | 0.51 | 0.41 | | |
| b2 | 0.200 | 0.350 | 0.273 | | |
| b3 | 0.40 | 0.80 | 0.60 | | |
| С | 0.230 | 0.330 | 0.277 | | |
| D | | 5.15 BSC | ; | | |
| D1 | 4.70 | 5.10 | 4.90 | | |
| D2 | 3.70 | 4.10 | 3.90 | | |
| D3 | 3.90 | 4.30 | 4.10 | | |
| E | | 6.15 BSC | ; | | |
| E1 | 5.60 | 6.00 | 5.80 | | |
| E2 | 3.28 | 3.68 | 3.48 | | |
| E3 | 3.99 | 4.39 | 4.19 | | |
| е | | 1.27 BSC | ; | | |
| G | 0.51 | 0.71 | 0.61 | | |
| K | 0.51 | - | - | | |
| L | 0.51 | 0.71 | 0.61 | | |
| L1 | 0.100 | 0.200 | 0.175 | | |
| М | 3.235 | 4.035 | 3.635 | | |
| M1 | 1.00 | 1.40 | 1.21 | | |
| Θ | 10° | 12° | 11° | | |
| Θ1 | 6° | 8° | 7° | | |
| Al | All Dimensions in mm | | | | |

Site 2:

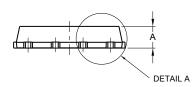


PowerDI5060-8/SWP (Type UX)

PowerDI5060-8



DETAIL A



| | PowerDI5060-8/SWP (Type UX) | | | |
|----------------------|--------------------------------|---------|--|--|
| Dim | Min | Max | Тур | |
| Α | 0.90 | 1.10 | 1.00 | |
| A1 | 0 | 0.05 | | |
| b | 0.30 | 0.50 | 0.41 | |
| b2 | 0.20 | 0.35 | 0.25 | |
| b4 | (|).25REF | - | |
| С | 0.230 | 0.330 | 0.277 | |
| D | 5 | .15 BS0 | C | |
| D1 | 4.70 | 5.10 | 4.90 | |
| D2 | 3.56 | 3.96 | 3.76 | |
| D2a | 3.78 | 4.18 | 3.98 | |
| Е | 6 | .40 BS0 | 2 | |
| E1 | 5.60 | 6.00 | 5.80 | |
| E2 | 3.46 | 3.86 | 3.66 | |
| E2a | 4.195 | 4.595 | 4.395 | |
| е | 1 | .27BSC | <u>) </u> | |
| k | 1.05 | | | |
| L | 0.635 | 0.835 | 0.735 | |
| La | 0.635 | 0.835 | 0.735 | |
| L1 | 0.200 | 0.400 | 0.300 | |
| L1a | 0 | .050RE | F | |
| L4 | 0.025 | 0.225 | 0.125 | |
| М | 3.205 | 4.005 | 3.605 | |
| θ | 10° | 12° | 11° | |
| θ1 | 6° | 8° | 7° | |
| All Dimensions in mm | | | | |

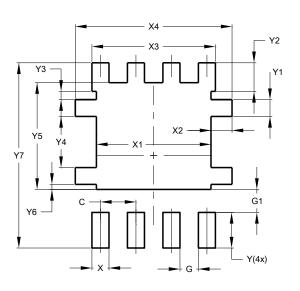
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Suggested Pad Layout

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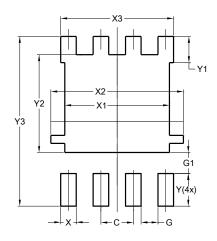


| Dimensions | Value (in mm) |
|------------|---------------|
| С | 1.270 |
| G | 0.660 |
| G1 | 0.820 |
| Х | 0.610 |
| X1 | 4.100 |
| X2 | 0.755 |
| X3 | 4.420 |
| X4 | 5.610 |
| Y | 1.270 |
| Y1 | 0.600 |
| Y2 | 1.020 |
| Y3 | 0.295 |
| Y4 | 1.825 |
| Y5 | 3.810 |
| Y6 | 0.180 |
| Y7 | 6.610 |

Site 2:

PowerDI5060-8/SWP (Type UX)

PowerDI5060-8



| Dimensions | Value (in mm) |
|------------|------------------|
| С | 1.270 |
| G | 0.660 |
| G1 | 0.820 |
| Х | 0.610 |
| X1 | 4.100 |
| X2 | 5.190 |
| X3 | 4.420 |
| Y | 1.270 |
| Y1 | 1.020 |
| Y2 | 3.810 |
| Y3 | 6.610 |

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